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MOSFET - Power, Single N-Channel, SO-8FL 30 V, 52 A NTMFS4C08N

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- CPU Power Delivery
- DC-DC Converters

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise stated)

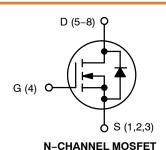
| Parameter | | | Symbol | Value | Unit |
|--|---|--|-----------------------------------|----------------|------|
| Drain-to-Source Voltage | | | V _{DSS} | 30 | V |
| Gate-to-Source Voltage | | V _{GS} | ±20 | V | |
| Continuous Drain Current R _{θJA} (Note 2) | | $T_A = 25^{\circ}C$ $T_A = 80^{\circ}C$ | ۱ _D | 16.4 12.3 | A |
| Power Dissipation $R_{\theta JA}$ (Note 2) | | $T_A = 25^{\circ}C$ | PD | 2.51 | W |
| Continuous Drain Current $R_{\theta JA} \le 10 \text{ s}$ | | $T_A = 25^{\circ}C$ $T_A = 80^{\circ}C$ | ۱ _D | 25.3 19.0 | A |
| (Note 2) Power Dissipation $R_{\theta JA} \le 10 \text{ s}$ (Note 2) | Steady | $T_A = 25^{\circ}C$ | P _D | 6.0 | W |
| Continuous Drain | State | T _A = 25°C | Ι _D | 9.0 | А |
| Current R _{0JA} (Note 3) | | T _A = 80°C | | 6.8 | |
| Power Dissipation $R_{\theta JA}$ (Note 3) | | $T_A = 25^{\circ}C$ | PD | 0.76 | W |
| Continuous Drain Current R _{θJC} (Note 2) | | T _C = 25°C T _C =80°C | ۱ _D | 52 39 | А |
| Power Dissipation $R_{\theta JC}$ (Note 2) | | $T_{\rm C} = 80^{\circ}{\rm C}$ $T_{\rm C} = 25^{\circ}{\rm C}$ | P _D | 25.5 | W |
| Pulsed Drain Current | T _A = 25°C, t _p = 10 μs | | I _{DM} | 144 | А |
| Pulsed Source Current (Body Diode) | T _A = 25° | $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ | | 560 | A |
| Current Limited by Pac | kage | T _A = 25°C | I _{Dmax} | 80 | А |
| Operating Junction and Storage Temperature Range | | | T _J , T _{STG} | –55 to +150 | °C |
| Source Current (Body Diode) | | | I _S | 23 | А |
| Drain to Source DV/DT | | | dV/d _t | 7.0 | V/ns |
| Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, V _{GS} = 10 V, I _L = 29 A _{pk} , L = 0.1 mH, R _{GS} = 25 Ω) (Note 4) | | | E _{AS} | 42 | mJ |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | ΤL | 260 | °C |

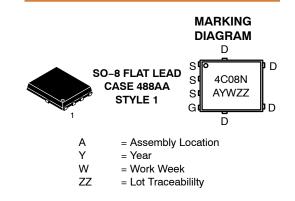
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.

- 3. Surface-mounted on FR4 board using the minimum recommended pad size.
- 4. This is the absolute maximum rating. Parts are 100% tested at $T_J = 25^{\circ}C$,
- V_{GS} = 10 V, I_L = 21 Apk, E_{AS} = 22 mJ.

| V _{(BR)DSS} | R _{DS(ON)} MAX | I _D MAX |
|----------------------|-------------------------|--------------------|
| 30 V | 5.8 mΩ @ 10 V | 52 A |
| 30 V | 8.5 mΩ @ 4.5 V | 52 A |





ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------------|----------------------|-----------------------|
| NTMFS4C08NT1G | SO-8 FL (Pb-Free) | 1500 / Tape & Reel |

DISCONTINUED (Note 1)

| SO-8 FL | 5000 / |
|-----------|-------------|
| (Pb-Free) | Tape & Reel |
| | |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

 DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

THERMAL RESISTANCE MAXIMUM RATINGS

| Parameter | Symbol | Value | Unit |
|--|---------------------|-------|------|
| Junction-to-Case (Drain) | $R_{	ext{	heta}JC}$ | 4.9 | |
| Junction-to-Ambient - Steady State (Note 5) | $R_{\theta JA}$ | 49.8 | °C/W |
| Junction-to-Ambient - Steady State (Note 6) | $R_{\theta JA}$ | 164.6 | °C/W |
| Junction-to-Ambient – (t \leq 10 s) (Note 5) | $R_{	hetaJA}$ | 21.0 | |

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
 Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

| - | Test Condition | | Min | Тур | Мах | Unit |
|--|--|---|--|--|--|--|
| | | | | | | |
| V _{(BR)DSS} | V_{GS} = 0 V, I_D = 250 μ A | | 30 | | | V |
| V _{(BR)DSSt} | V_{GS} = 0 V, $I_{D(aval)}$ = 8.4 A, T_{case} = 25°C, $t_{transient}$ = 100 ns | | 34 | | | V |
| V _{(BR)DSS} / T _J | | | | 13.8 | | mV/°C |
| I _{DSS} | V _{GS} = 0 V, V _{DS} = 24 V | $T_J = 25^{\circ}C$ | | | 1.0 | |
| | | $T_J = 125^{\circ}C$ | | | 10 | μA |
| I _{GSS} | $V_{DS} = 0 V, V_{GS}$ | _S = ±20 V | | | ±100 | nA |
| | | | | | | |
| V _{GS(TH)} | $V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$ | | 1.3 | | 2.1 | V |
| V _{GS(TH)} /T _J | | | | 4.9 | | mV/°C |
| 20(0) | V _{GS} = 10 V | I _D = 18 A | | 4.6 | 5.8 | mΩ |
| | V _{GS} = 4.5 V | I _D = 30 A | | 6.8 | 8.5 | |
| 9 _{FS} | V _{DS} = 1.5 V, I _D = 15 A | | | 42 | | S |
| R _G | T _A = 25°C | | 0.3 | 1.0 | 2.0 | Ω |
| | | | | | | |
| C _{ISS} | | | | 1113 | 1670 | |
| C _{OSS} | V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V | | | 702 | | pF |
| C _{RSS} | | | | 39 | | |
| C _{RSS} /C _{ISS} | V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz | | | 0.035 | | |
| Q _{G(TOT)} | | | | 8.4 | | |
| Q _{G(TH)} | V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A | | | 1.8 | | nC |
| Q _{GS} | | | | 3.5 | | |
| Q _{GD} | 1 | | | 3.3 | | |
| V _{GP} | 1 | | | 3.4 | | V |
| | V_{GS} = 10 V, V_{DS} = 15 V; I_{D} = 30 A | | | 18.2 | | nC |
| | V(BR)DSSt V(BR)DSSt TJ IDSS IGSS VGS(TH) VGS(TH)/TJ RDS(on) 9FS RG 0FS RG CISS CRSS CRSS CRSS CRSS CRSS CRSS CRSS | $\begin{tabular}{ c c c c c c c c c c c } \hline V_{(BR)DSSt} & V_{GS} = 0 \ V, \ I_{D(av}\\ T_{case} = 25^\circ C, \ t_{trans} \\ \hline V_{(BR)DSS'} \\ \hline I_{DS} & V_{GS} = 0 \ V, \\ V_{DS} = 24 \ V \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} \\ \hline V_{GS}(TH) & V_{GS} = 0 \ V, \ V_{GS} \\ \hline V_{GS}(TH)/T_J & \\ \hline V_{GS}(TH)/T_J & \\ \hline V_{GS}(TH)/T_J & \\ \hline R_{DS}(on) & V_{GS} = 10 \ V \\ \hline V_{GS} = 4.5 \ V \\ \hline SFS & V_{DS} = 1.5 \ V, \ I \\ \hline R_{G} & T_A = 25 \\ \hline \hline C_{ISS} & \\ \hline C_{RSS} & \\ \hline C_{RSS}/C_{ISS} & V_{GS} = 0 \ V, \ f = 1 \ MH \\ \hline C_{RSS} & \\ \hline Q_{G}(TTH) & \\ \hline Q_{G}(TH) & \\ \hline Q_{GS} & \\ \hline V_{GS} = 4.5 \ V, \ V_{DS} = 1 \\ \hline \end{tabular}$ | $\begin{array}{ c c c c c } V_{(BR)DSSt} & V_{GS} = 0 \ V, \ I_{D}(aval) = 8.4 \ A, \\ T_{case} = 25^{\circ}C, \ t_{transient} = 100 \ ns \end{array}$ $\begin{array}{ c c c c } V_{(BR)DSS'} & T_{J} = 25^{\circ}C \\ \hline V_{DS} = 24 \ V & T_{J} = 25^{\circ}C \\ \hline T_{J} = 125^{\circ}C \\ \hline T_{J} = 125^{\circ}C \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{GS}(TH) & V_{GS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{GS}(TH)/T_{J} & H_{DS}(on) & V_{GS} = 10 \ V & I_{D} = 18 \ A \\ \hline V_{GS} = 4.5 \ V & I_{D} = 30 \ A \\ \hline V_{GS} = 0 \ V, \ I_{D} = 15 \ A \\ \hline R_{G} & T_{A} = 25^{\circ}C \\ \hline \hline C_{ISS} & V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 15 \ V \\ \hline C_{RSS} & V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 15 \ V, \ f = 1 \ MHz \\ \hline Q_{G}(TT) & Q_{G}(TH) \\ \hline Q_{GS} & V_{GS} = 4.5 \ V, \ V_{DS} = 15 \ V, \ f = 1 \ MHz \\ \hline Q_{GG} & V_{GS} = 4.5 \ V, \ V_{DS} = 15 \ V; \ I_{D} = 30 \ A \\ \hline \end{array}$ | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ |

Turn-On Delay Time t_{d(ON)} 9.0 **Rise Time** t_r 33 $\begin{array}{l} \mathsf{V}_{GS} = 4.5 \; \mathsf{V}, \, \mathsf{V}_{DS} = 15 \; \mathsf{V}, \\ \mathsf{I}_{D} = 15 \; \mathsf{A}, \, \mathsf{R}_{G} = 3.0 \; \Omega \end{array}$ ns Turn-Off Delay Time 15 $t_{d(OFF)}$ Fall Time 4.0 t_f

7. Pulse Test: pulse width \leq 300 $\mu s,$ duty cycle \leq 2%.

8. Switching characteristics are independent of operating junction temperatures.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

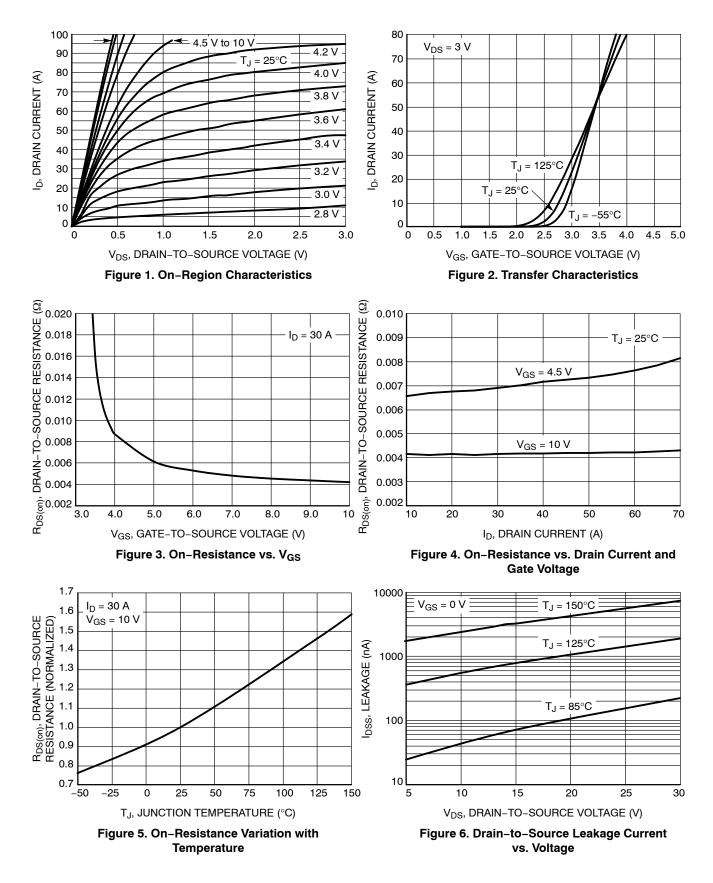
| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|-------------------------------|---------------------|--|------------------------|------|------|-----|------|
| SWITCHING CHARACTERISTICS (No | te 8) | • | | | | | |
| Turn-On Delay Time | t _{d(ON)} | V_{GS} = 10 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω | | | 7.0 | | ns |
| Rise Time | t _r | | | | 26 | | |
| Turn-Off Delay Time | t _{d(OFF)} | | | | 19 | | |
| Fall Time | t _f | | | | 3.0 | | |
| DRAIN-SOURCE DIODE CHARACTE | RISTICS | • • | | | | | |
| Forward Diode Voltage | V _{SD} | V _{GS} = 0 V, I _S = 10 A | $T_J = 25^{\circ}C$ | | 0.79 | 1.1 | |
| | | | T _J = 125°C | | 0.66 | | V |
| Reverse Recovery Time | t _{RR} | V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 30 A | | | 28.3 | | |
| Charge Time | t _a | | | | 14.5 | | ns |
| Discharge Time | t _b | | | | 13.8 | | |
| Reverse Recovery Charge | Q _{RR} | | | 15.3 | | nC | |

7. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%.

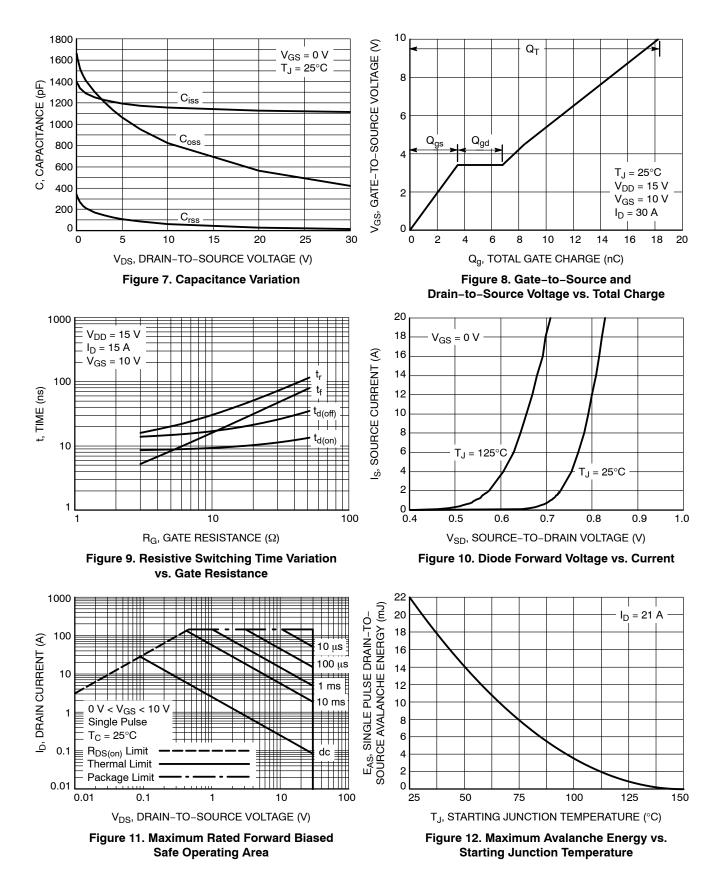
8. Switching characteristics are independent of operating junction temperatures.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

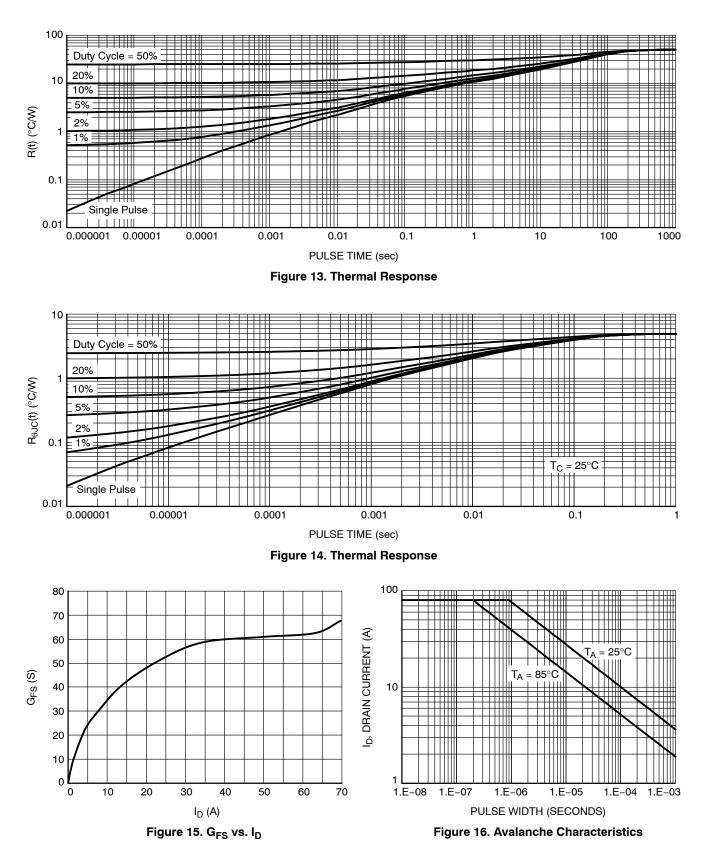
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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